

Diode

Silicon Carbide Schottky Diode

IDH02G120C5

5th Generation CoolSiC[™] 1200 V SiC Schottky Diode

Final Datasheet

Rev. 2.1 2017-07-21

Industrial Power Control

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5th Generation CoolSiC[™] 1200 V SiC Schottky Diode

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CoolSiC[™] SiC Schottky Diode

Features:

- Revolutionary semiconductor material Silicon Carbide
- No reverse recovery current / No forward recovery
- Temperature independent switching behavior
- Low forward voltage even at high operating temperature
- Tight forward voltage distribution
- Excellent thermal performance
- Extended surge current capability
- Specified dv/dt ruggedness
- Qualified according to JEDEC¹⁾ for target applications
- Pb-free lead plating; RoHS compliant

Benefits

- System efficiency improvement over Si diodes
- Enabling higher frequency / increased power density solutions
- System size / cost savings due to reduced heatsink requirements and smaller magnetics
- Reduced EMI
- Highest efficiency across the entire load range
- Robust diode operation during surge events
- High reliability
- RelatedLinks: <u>www.infineon.com/sic</u>

Applications

- Solar inverters
- Uninterruptable power supplies
- Motor drives
- Power Factor Correction

Package pin definitions

- Pin 1 and backside cathode
- Pin 2 anode



Key Performance and Package Parameters

Туре	V _{DC}	l _F	Q _c	T _{j,max}	Marking	Package
IDH02G120C5	1200V	2A	14nC	175°C	D0212C5	PG-TO220-2-1

1) J-STD20 and JESD22

Final Data Sheet

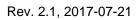






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Maximum ratings

Parameter	Symbol	Value	Unit	
Repetitive peak reverse voltage	V _{RRM}	1200	V	
Continues forward current for $R_{th(j-c,max)}$ $T_c = 168^{\circ}C, D=1$ $T_c = 135^{\circ}C, D=1$ $T_c = 25^{\circ}C, D=1$	IF	2 5.7 11.8	A	
Surge non-repetitive forward current, sine halfwave $T_c=25^{\circ}C$, $t_p=10ms$ $T_c=150^{\circ}C$, $t_p=10ms$	I _{F,SM}	37 31	A	
Non-repetitive peak forward current $T_{\rm C} = 25^{\circ}{\rm C}, t_{\rm p}=10 \ \mu{\rm s}$	I _{F,max}	344	А	
ⁱ² t value $T_{\rm C} = 25^{\circ}{\rm C}, t_{\rm p} = 10 \text{ ms}$ $T_{\rm C} = 150^{\circ}{\rm C}, t_{\rm p} = 10 \text{ ms}$	∫ i²dt	7 4.9	A²s	
Diode dv/dt ruggedness V _R =0960V	dv/dt	80	V/ns	
Power dissipation $T_{\rm C} = 25^{\circ}{\rm C}$	P _{tot}	75	W	
Operating and storage temperature	$T_{\rm j}$; $T_{\rm stg}$	-55175	°C	
Soldering temperature, wavesoldering only allowed at leads, 1.6mm (0.063 in.) from case for 10 s	T _{sold}	260	°C	
Mounting torque M3 and M4 screws	М	0.7	Nm	

Thermal Resistances

Parameter	Symbol	Conditions min.		Value	Unit	
Falameter	Symbol		min.	typ.	max.	Unit
Characteristic						
Diode thermal resistance, junction – case	R _{th(j-c)}		-	1.54	2	K/W
Thermal resistance, junction – ambient	R _{th(j-a)}	leaded	-	-	62	K/W



Electrical Characterics

Static Characteristics, at T_j=25°C, unless otherwise specified

Parameter	Symbol	Conditions min.		Value	Unit	
Falameter			min.	typ.	max.	Onit
Static Characteristic						
DC blocking voltage	V _{DC}	$T_{\rm j} = 25^{\circ}{\rm C}$	1200	-	-	V
Diode forward voltage	V _F	$I_{\rm F}$ = 2A, $T_{\rm j}$ =25°C	-	1.4	1.65	V
Didde forward voltage		$I_{\rm F}$ = 2A, $T_{\rm j}$ =150°C	-	1.7	2.3	
Reverse current	1	V _R =1200V, <i>T</i> _j =25°C		1.2	18	μA
	I _R	V _R =1200V, <i>T</i> _j =150°C		6	90	

Dynamic Characteristics, at $T_j=25$ °C, unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
Farameter	Symbol		min.	typ.	max.	Onit
Dynamic Characteristics						
Total capacitive charge	Q _c	$V_{\rm R}=800\rm V, \ T_{\rm j}=150\rm °C$ $Q_{\rm C}=\int_{0}^{V_{\rm R}}C(V)dV$	-	14	-	nC
Total Capacitance	С	V _R =1 V, <i>f</i> =1 MHz V _R =400 V, <i>f</i> =1 MHz V _R =800 V, <i>f</i> =1 MHz		182 13 10		pF



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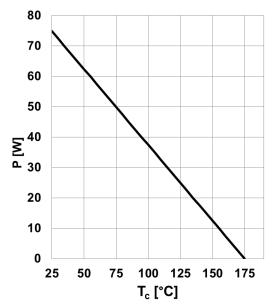


Figure 1. Power dissipation as a function of case temperature, $P_{tot}=f(T_C)$, $R_{th(j-c),max}$

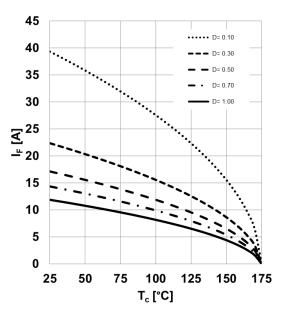
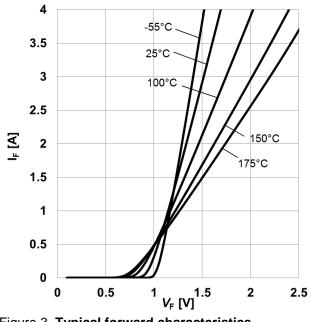
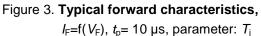


Figure 2. Diode forward current as function of temperature, $T_j \le 175^{\circ}$ C, $R_{th(j-c),max}$, parameter D=duty cycle, V_{th} , R_{diff} @ $T_j=175^{\circ}$ C





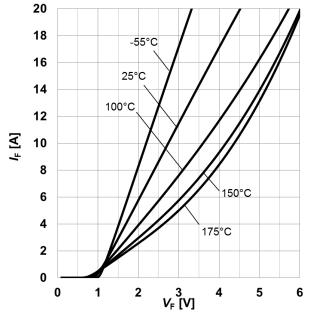


Figure 4. Typical forward characteristics in surge current, $I_F=f(V_F)$, $t_p=10 \ \mu s$, parameter: T_i



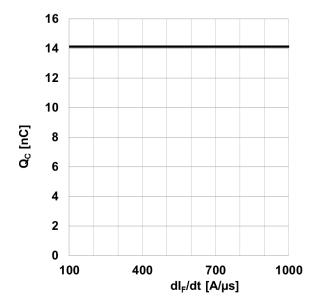


Figure 5. Typical capacitive charge as function of current slope¹, $Q_C=f(dI_F/dt)$, $T_j=150$ °C 1) Only capacitive charge, guaranteed by design.

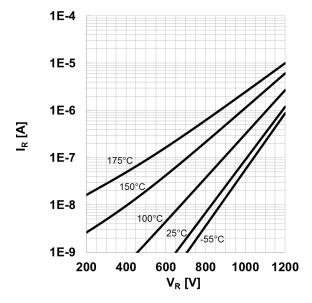
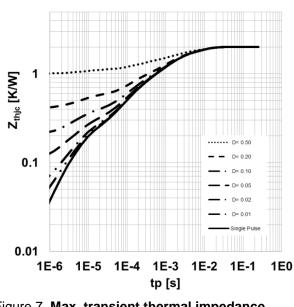
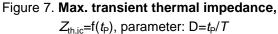


Figure 6. Typical reverse current as function of reverse voltage, $I_R=f(V_R)$, parameter: T_i





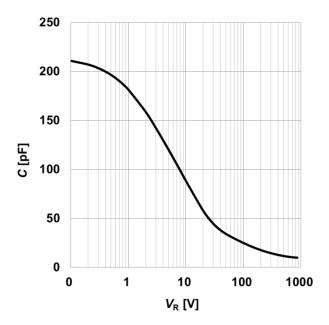


Figure 8. Typical capacitance as function of reverse voltage, $C=f(V_R)$; $T_i=25^{\circ}C$; f=1 MHz



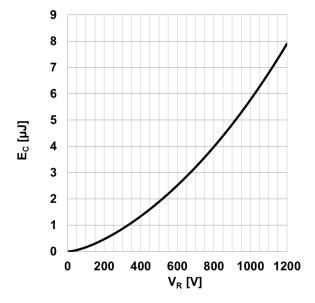


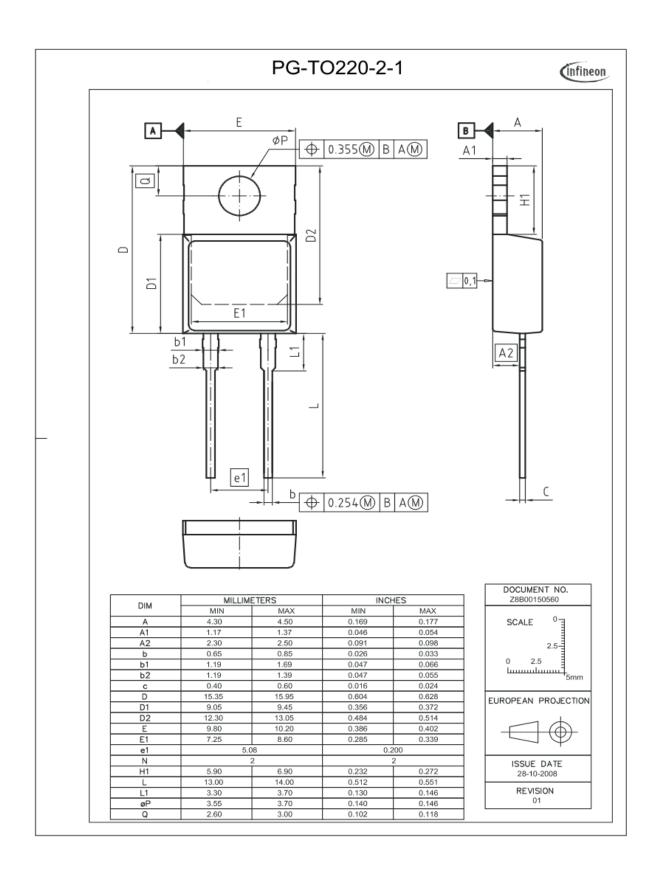
Figure 9. Typical capacitively stored energy as function of reverse voltage,

$$E_C = \int_0^{V_R} C(V) V dV$$



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Revision History

IDH02G120C5

Revision:2017-07-12, Rev. 2.1

Previous Revision:					
Revision	Date	Subjects (major changes since last version)			
2.0	2015-07-22 Final data sheet				
2.1	-	Editorial change			

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